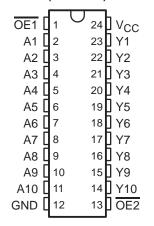
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- Operates From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max t<sub>pd</sub> of 6.7 ns at 3.3 V
- Typical V<sub>OLP</sub> (Output Ground Bounce) <0.8 V at  $V_{CC} = 3.3 \text{ V}, T_{\Delta} = 25^{\circ}\text{C}$
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot) >2 V at  $V_{CC} = 3.3$  V,  $T_A = 25$ °C
- **Supports Mixed-Mode Signal Operation on** All Ports (5-V Input/Output Voltage With 3.3-V V<sub>CC</sub>)
- Ioff Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 250 mA Per **JESD 17**
- **ESD Protection Exceeds JESD 22** 
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

#### DB, DGV, DW, NS, OR PW PACKAGE (TOP VIEW)



## description/ordering information

This 10-bit buffer/bus driver is designed for 1.65-V to 3.6-V V<sub>CC</sub> operation.

The SN74LVC827A provides a high-performance bus interface for wide data paths or buses carrying parity.

The 3-state control gate is a 2-input AND gate with active-low inputs so that, if either output-enable (OE1 or OE2) input is high, all ten outputs are in the high-impedance state. The SN74LVC827A provides true data at its outputs.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of this device as a translator in a mixed 3.3-V/5-V system environment.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

#### ORDERING INFORMATION

TA	PACKAGE <sup>†</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	0010 DW	Tube of 25	SN74LVC827ADW	11/00074
	SOIC - DW	Reel of 2000	SN74LVC827ADWR	LVC827A
	SOP - NS	Reel of 2000	SN74LVC827ANSR	LVC827A
4000 to 0500	SSOP – DB	Reel of 2000	SN74LVC827ADBR	LC827A
-40°C to 85°C		Tube of 60	SN74LVC827APW	
	TSSOP - PW	Reel of 2000	SN74LVC827APWR	LC827A
		Reel of 250	SN74LVC827APWT	
	TVSOP - DGV	Reel of 2000	SN74LVC827ADGVR	LC827A

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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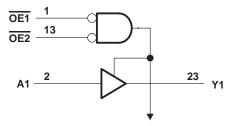
#### description/ordering information (continued)

This device is fully specified for partial-power-down applications using I<sub>off</sub>. The I<sub>off</sub> circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

#### **FUNCTION TABLE**

	INPUTS	OUTPUT	
OE1	OE2	Α	Y
L	L	L	L
L	L	Н	Н
Н	X	Χ	Z
Х	Н	Χ	Z

#### logic diagram (positive logic)



To Nine Other Channels

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>		
Voltage range applied to any output in the high (see Note 1)		-0.5 V to 6.5 V
Voltage range applied to any output in the high		0.0 v to 0.0 v
(see Notes 1 and 2)		-0.5 V to V <sub>CC</sub> + 0.5 V
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)		
Output clamp current, $I_{OK}$ ( $V_O < 0$ )		
Continuous output current, IO		
Continuous current through V <sub>CC</sub> or GND		
Package thermal impedance, θ <sub>JA</sub> (see Note 3)		
, , , , , , , , , , , , , , , , , , , ,	DGV package	
	DW package	
	NS package	
	PW package	
Storage temperature range, T <sub>stg</sub>	. •	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
  - 2. The value of V<sub>CC</sub> is provided in the recommended operating conditions table.
  - 3. The package thermal impedance is calculated in accordance with JESD 51-7.



# recommended operating conditions (see Note 4)

			MIN	MAX	UNIT	
V	Cumhusoltogo	Operating	1.65	3.6	V	
vCC	V <sub>CC</sub> Supply voltage	Data retention only	1.5		V	
		V <sub>CC</sub> = 1.65 V to 1.95 V	0.65 × V <sub>CC</sub>			
ViH	High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2			
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		$0.35 \times V_{CC}$		
VIL	Low-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8		
VI	Input voltage		0	5.5	V	
.,	0	High or low state	0	VCC	.,	
VO	Output voltage	3-state	0	5.5	V	
		V <sub>CC</sub> = 1.65 V		-4		
	High-level output current	V <sub>CC</sub> = 2.3 V		-8	mA	
ЮН		V <sub>CC</sub> = 2.7 V		-12		
		V <sub>CC</sub> = 3 V		-24		
		V <sub>CC</sub> = 1.65 V		4		
		V <sub>CC</sub> = 2.3 V		8		
lOL	Low-level output current	V <sub>CC</sub> = 2.7 V		12	mA	
		V <sub>CC</sub> = 3 V		24		
Δt/Δν	Input transition rise or fall rate	•		10	ns/V	
TA	Operating free-air temperature		-40	85	°C	

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CO	V <sub>CC</sub>	MIN	TYP <sup>†</sup>	MAX	UNIT	
	$I_{OH} = -100  \mu A$		1.65 V to 3.6 V	V <sub>CC</sub> -0.2			
	$I_{OH} = -4 \text{ mA}$	1.65 V	1.2				
l v	I <sub>OH</sub> = -8 mA		2.3 V	1.7			V
VOH	10 1		2.7 V	2.2			V
	I <sub>OH</sub> = −12 mA		3 V	2.4			
	I <sub>OH</sub> = -24 mA		3 V	2.2			
	I <sub>OL</sub> = 100 μA		1.65 V to 3.6 V			0.2	
	I <sub>OL</sub> = 4 mA	1.65 V			0.45		
VOL	I <sub>OL</sub> = 8 mA	2.3 V			0.7	V	
	I <sub>OL</sub> = 12 mA	2.7 V			0.4		
	I <sub>OL</sub> = 24 mA		3 V			0.55	
IĮ	$V_{I} = 0 \text{ to } 5.5 \text{ V}$		3.6 V			±5	μΑ
loff	$V_I$ or $V_O = 5.5 V$		0			±10	μΑ
loz	$V_0 = 0 \text{ to } 5.5 \text{ V}$		3.6 V			±10	μΑ
	$V_I = V_{CC}$ or GND					10	
lcc	$3.6 \text{ V} \le \text{V}_1 \le 5.5 \text{ V}^{\ddagger}$	IO = 0	3.6 V	1		10	μΑ
ΔlCC	One input at V <sub>CC</sub> – 0.6 V,	Other inputs at V <sub>CC</sub> or GND	2.7 V to 3.6 V			500	μΑ
Control inputs	V V OND		0.01/		5		
C <sub>i</sub> Data inputs	$V_I = V_{CC}$ or GND		3.3 V		4		рF
Co	$V_O = V_{CC}$ or GND		3.3 V		7		pF

 $<sup>\</sup>dagger$  All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

#### switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	FROM (INPUT)		TO (OUTPUT)	V <sub>CC</sub> = ± 0.1	1.8 V 5 V	V <sub>CC</sub> =	2.5 V 2 V	V <sub>CC</sub> =	2.7 V	V <sub>CC</sub> =	3.3 V 3 V	UNIT
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX			
t <sub>pd</sub>	А	Υ	§	§	§	§		7.1	1	6.7	ns		
t <sub>en</sub>	ŌĒ	Υ	§	§	§	§		8.5	1	7.3	ns		
t <sub>dis</sub>	ŌĒ	Y	§	§	§	§		7.3	1.8	6.7	ns		
tsk(o)										1	ns		

<sup>§</sup> This information was not available at the time of publication.

# operating characteristics, T<sub>A</sub> = 25°C

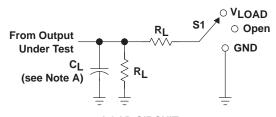
	PARAMETER	TEST	V <sub>CC</sub> = 1.8 V	V <sub>CC</sub> = 2.5 V	V <sub>CC</sub> = 3.3 V	UNIT	
TANAMETER		CONDITIONS	TYP	TYP	TYP	ONT	
C <sub>pd</sub>	Power dissipation capacitance	Outputs enabled	f = 10 MHz	§	§	24	PΓ
opa	per buffer/driver	Outputs disabled	1 = 10 MHZ	§	§	5	þг

<sup>§</sup> This information was not available at the time of publication.



<sup>&</sup>lt;sup>‡</sup> This applies in the disabled state only.

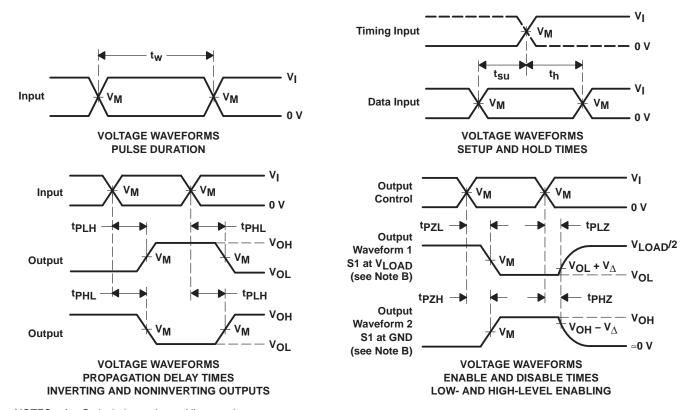
#### PARAMETER MEASUREMENT INFORMATION



TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	VLOAD
<sup>t</sup> PHZ <sup>/t</sup> PZH	GND

LOAD CIRCUIT	IRCUIT	IR	C	D	A	LO	
--------------	--------	----	---	---	---	----	--

W = -	INF	PUTS		V	0	6	, ,
VCC	٧ <sub>I</sub>	t <sub>r</sub> /t <sub>f</sub>	VM	VLOAD	CL	$R_L$	$oldsymbol{V}_\Delta$
1.8 V $\pm$ 0.15 V	VCC	≤2 ns	V <sub>CC</sub> /2	2×V <sub>CC</sub>	30 pF	<b>1 k</b> Ω	0.15 V
2.5 V $\pm$ 0.2 V	VCC	≤ <b>2</b> ns	V <sub>CC</sub> /2	2×V <sub>CC</sub>	30 pF	500 $\Omega$	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 $\Omega$	0.3 V
3.3 V $\pm$ 0.3 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 $\Omega$	0.3 V



NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_{O} = 50 \Omega$ .
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



## DGV (R-PDSO-G\*\*)

#### **24 PINS SHOWN**

#### **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

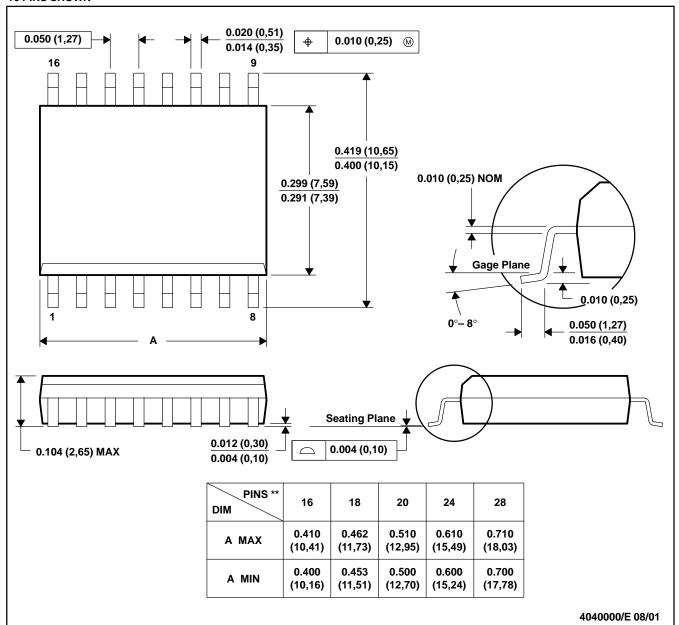
D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194



#### DW (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

#### **16 PINS SHOWN**



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013

## **MECHANICAL DATA**

# NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

#### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

## PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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